

### SI6415DQ-T1-GE3-VB Datasheet

# P-Channel 20-V (G-S) MOSFET

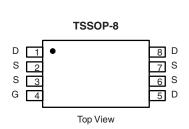
PRODUCT SUMMARY				
V <sub>DS</sub> (V)	$R_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A)		
	0.010 at V <sub>GS</sub> = - 4.5 V	- 9.0		
-20	0.012 at V <sub>GS</sub> = - 2.5 V	- 7.8		
	0.016 at V <sub>GS</sub> = - 1.8 V	- 6.0		

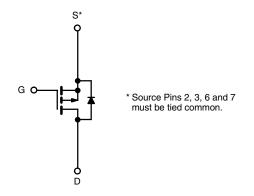
#### **FEATURES**

- Halogen-free
- Trench Power MOSFETs









P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T <sub>A</sub> = 25 °C, unless otherwise noted					
Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage		$V_{DS}$	-20		V
Gate-Source Voltage		V <sub>GS</sub>	± 12		
Opening Special Comment (T. 150,00)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	- 9.0	-7.8	•
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a</sup>	T <sub>A</sub> = 70 °C		- 6.8	-5.8	
Pulsed Drain Current (10 μs Pulse Width)		I <sub>DM</sub>	- 30		Α
Continuous Source Current (Diode Conduction) <sup>a</sup>		I <sub>S</sub>	- 1.35	- 0.95	
M	T <sub>A</sub> = 25 °C	P <sub>D</sub>	1.5	1.05	w
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 70 °C		1.0	0.67	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150		°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Manipania Institut to Applicate	t ≤ 10 s	$R_{thJA}$	65	83	
Maximum Junction-to-Ambient <sup>a</sup>	Steady State		100	120	°C/W
Maximum Junction-to-Foot (Drain)	Steady State	$R_{thJF}$	43	52	

Notes: a. Surface Mounted on 1" x 1" FR4 board.

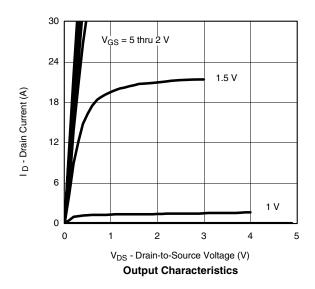


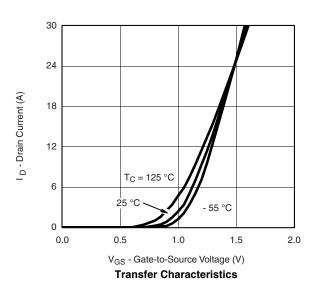
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = -450 \mu A$	- 0.45	-	1.0	V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA	
Zara Cata Valtaga Drain Current	,	V <sub>DS</sub> = - 20 V, V <sub>GS</sub> = 0 V			- 1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ = -20V, V $_{GS}$ = 0 V, $T_{J}$ = 70 °C			- 25	μΑ	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> = - 5 V, V <sub>GS</sub> = - 4.5 V	- 20			Α	
		V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 8.0 A		0.010			
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 2.5 V, I <sub>D</sub> = - 7.0 A		0.012		Ω	
		V <sub>GS</sub> = - 1.8 V, I <sub>D</sub> = - 5.8 A		0.016			
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 5 V, I <sub>D</sub> = - 8.0 A		44		S	
Diode Forward Voltage <sup>a</sup>	$V_{SD}$	I <sub>S</sub> = - 1.5 A, V <sub>GS</sub> = 0 V		- 0.56	- 1.1	V	
Dynamic <sup>b</sup>							
Total Gate Charge	$Q_g$			46	70		
Gate-Source Charge	$Q_{gs}$	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_D = -8.0 \text{ A}$		5		nC	
Gate-Drain Charge	$Q_{gd}$			15.5			
Turn-On Delay Time	t <sub>d(on)</sub>			45	70		
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 10 V, $R$ = 6 $\Omega$		85	130	ns	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D\cong$ - 1 A, $V_{GEN}=$ - 4.5 V, $R_g=$ 6 $\Omega$		220	400		
Fall Time	t <sub>f</sub>			155	235		
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = - 1.5 A, di/dt = 100 A/μs		140	210		

- Notes: a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %. b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

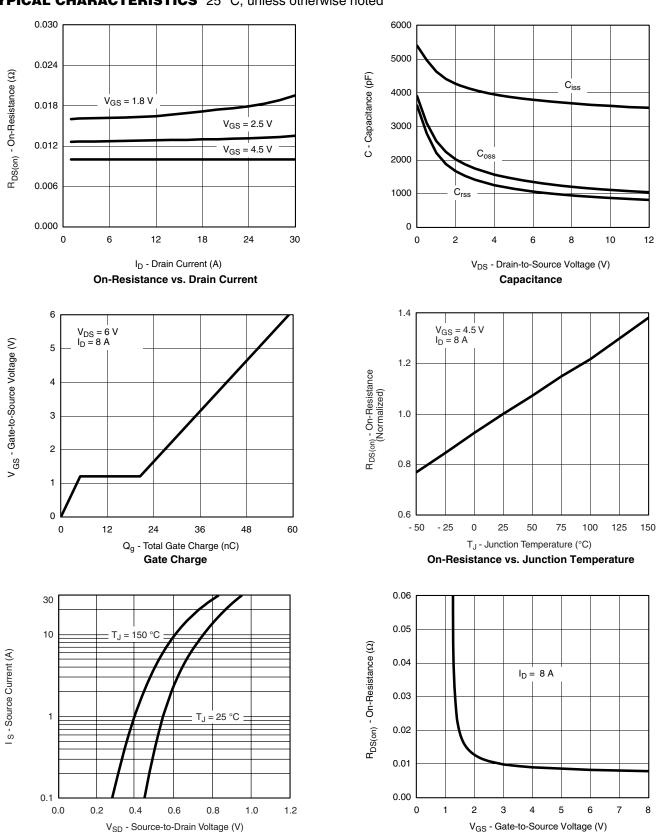
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted







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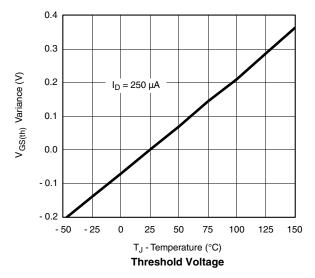


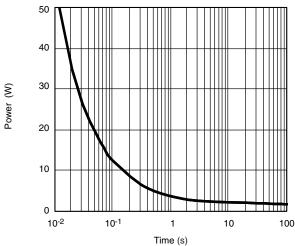
Source-Drain Diode Forward Voltage

On-Resistance vs. Gate-to-Source Voltage

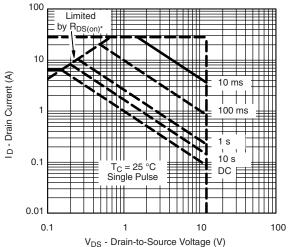


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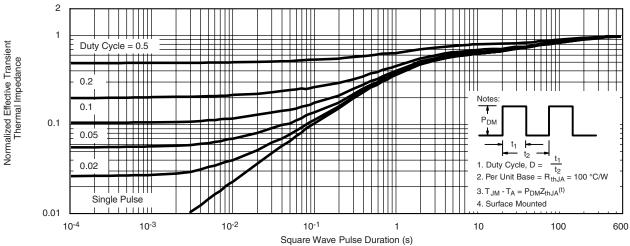




Single Pulse Power, Junction-to-Ambient



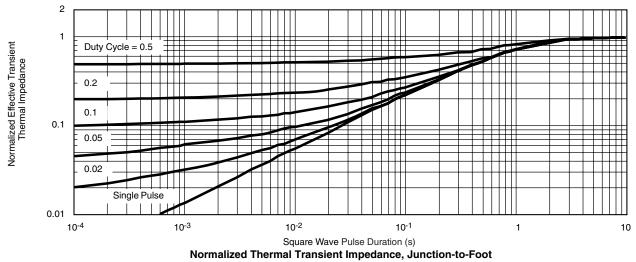
\* V<sub>GS</sub> > minimum V<sub>GS</sub> at which R<sub>DS(on)</sub> is specified **Safe Operating Area, Junction-to-Case** 



Normalized Thermal Transient Impedance, Junction-to-Ambient



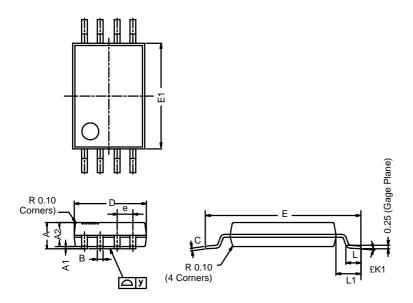
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TSSOP: 8-LEAD

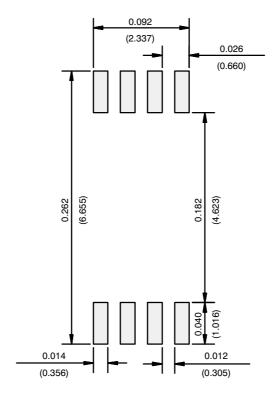
**JEDEC Part Number: MO-153** 



	MILLIMETERS				
Dim	Min	Nom	Max		
Α	_	_	1.20		
A <sub>1</sub>	0.05	0.10	0.15		
A <sub>2</sub>	0.80	1.00	1.05		
В	0.19	0.28	0.30		
С	-	0.127	-		
D	2.90	3.00	3.10		
E	6.20	6.40	6.60		
E <sub>1</sub>	4.30	4.40	4.50		
е	-	0.65	-		
L	0.45	0.60	0.75		
L <sub>1</sub>	0.90	1.00	1.10		
Y	_	-	0.10		
£K1	0°	3°	6°		
ECN: S-03946—Rev. G, 09-Jul-01 DWG: 5844					



#### **RECOMMENDED MINIMUM PADS FOR TSSOP-8**



Recommended Minimum Pads Dimensions in Inches/(mm)



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